



## **BRAINWARE UNIVERSITY**

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## **Term End Examination 2023** Programme - B.Tech.(ECE)-2019/B.Tech.(ECE)-2020 Course Name - VLSI Devices and Design Course Code - PCC-EC603 (Semester VI)

Full Marks: 60

Time: 2:30 Hours

[The figure in the margin indicates full marks. Candidates are required to give their answers in their own words as far as practicable.]

## Group-A

(Multiple Choice Type Question)

1 x 15=15

- Choose the correct alternative from the following:
- (i) Illustrate which of the following circuit designs can be best illustrated using the structural design domain:
  - a) Microprocessors

b) Memories

c) Counters

- d) Multiplexers
- (ii) Cite, what are the key considerations for full custom design:
  - a) Timing, area, power, cost

- b) Area, cost, reliability, security
- c) Timing, power, reliability, security
- d) Timing, area, reliability, security
- (iii) Explain the process to create a semi-custom design.
  - a) Full custom design

b) Integrated custom design

c) Standard cell design

- d) None of the above
- (iv) Identify the characteristics of semi-custom design.
  - a) Less design time

b) Low cost

c) Limited flexibility

d) All of the above

- (v) Define VLSI.
  - a) A type of software program

- b) A methodology for designing circuits
- c) A type of processor architecture
- d) A type of network protocol
- (vi) Identify the term used to describe a pre-designed, pre-characterized and pre-verified logic cell, that is typically used for ASIC design.
  - a) Macro cell

b) Analog cell

c) Memory cell

- d) Standard cell
- (vii) Develop an example of VLSI design concept.
  - a) Combinational circuit design

- b) Single transistor design
- c) Bipolar Junction Transistor design
- d) None of the above
- (viii) Determine the type of VLSI chip that is designed for a specific application.
  - a) Analog VLSI chips

b) Digital VLSI chips

c) General-purpose VLSI chips

d) ASIC

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	(ix)	Name a type of chip that can process both analog and digital signals.		
		-1 55.0	b) DSP	
	-	c) ASIC	d) CPLD	
	(x)	State the term used for a digital circuit that is decustomer or designer after manufacturing.	signed to be programmed by the	
V	time.	N/ A a series	b) PLA	
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	(xi)	Name a type of VLSI that is a type of ASIC which after manufacturing.	can be programmed by the customer	
		a) FPGA	b) PLA	
		c) LSI	d) MSI	
	(xii)	Choose the act of depositing a thin layer of silico	n onto a silicon wafer.	
			b) Etching	
		, , , , , , , , , , , , , , , , , , , ,	d) Photo-lithography	
	(xiii)	Choose a process of removing material from the		
		a) Oxidation	b) Diffusion	
	, · ·	c) Etching	d) Cleaning	
	(XIV)	<ul> <li>v) Choose the process of modifying the properties of a semiconductor material by adding impurities to it.</li> </ul>		
		a) Oxidation	b) Cleaning	
		c) Ion-implantation	d) Photo-lithography	
	(xv)	Name the type of chip that can be programmed	after being manufactured.	
		a) ASIC	b) PLA	
		c) LSI	d) FPGA	
		Group	n-B	
		(Short Answer Ty		3 x 5=15
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	2 F	xplain, how do VLSI chips influence modern techr	nology	(3)
	2. L 3. C	ompare and contrast analog and digital VLSI design	gn.	(3)
	4. S	elect two types of FPGA architectures.		(3)
	5. D	escribe analog VLSI design.		(3)
	6. C	ite the advantages of VLSI chips over earlier tech	nologies.	(3)
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	lo	dentify the disadvantages of VLSI chips over earlie	er technologies.	(3)
		Grou	p-C	
		(Long Answer Ty	-	5 x 6=30
	7.	Examine the impact of Moor's Law on VLSI design	n.	(5)
	8.	Exemine the role of diffusion in VLSI fabrication a	and its impact on chip performance.	(5)
	9.	Devise a truth table for a CMOS transmission gat	e.	(5)
	10.	Explain the differences between the FPGA and C	PLD architectures.	<b>(5)</b>
	11.	Explain how FPGA technology is used for hardwa	re emulation.	(5)
	12.	Design a stick diagram for a simple VLSI circuit ar OI		(5)
		Report the research on the latest developments	in VLSI fabrication technology, including	g (5)
		the challenges and future prospects.		

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